



DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **Characterization of CYP 2D6 Genotypes**, the specification of which was filed on **07/10/03** as Application Serial No. **10/617,070**. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

10/411,954
60/371,819

04/11/03
04/11/02

Pending
Abandoned

Application Serial No.

Filing Date

Patented, Pending or Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under § 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole or First Inventor: **Matt Neville**

Inventor's Signature: _____
Residence: 54 Kingston Road, Oxford OX2 6RH, England
Post Office Address: 54 Kingston Road, Oxford OX2 6RH, England

Date: _____
Citizenship: Great Britain

Full Name of Second Joint Inventor: **Monika de Arruda Indig**

Inventor's Signature: Monika de Arruda Indig
Residence: 6618 Montclair Lane, Madison, WI 53711
Post Office Address: 6618 Montclair Lane, Madison, WI 53711

Date: 12/10/03
Citizenship: United States of America

Full Name of Third Joint Inventor: **Feng Cao**

Inventor's Signature: Feng Cao
Residence: 2428 N. 111th Street, #6, Milwaukee, WI 53226
Post Office Address: 2428 N. 111th Street, #6, Milwaukee, WI 53226
617 Bradford Way, Hartland, WI 53029

Date: 12/10/03
Citizenship: People's Republic of China

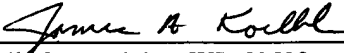
Full Name of Fourth Joint Inventor: **Mary C. Oldenburg**

Inventor's Signature: Mary C. Oldenburg
Residence: 30 North Third Street, Madison, WI 53704
Post Office Address: 30 North Third Street, Madison, WI 53704

Date: 12/10/03
Citizenship: USA

DECLARATION FOR PATENT APPLICATION (cont.)

Full Name of Fifth Joint Inventor: **James A. Koelbl**

Inventor's Signature: 
Residence: 1033 Tilda Trail, Cross Plains, WI 53528
Post Office Address: 1033 Tilda Trail, Cross Plains, WI 53528

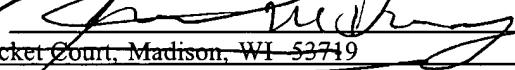
Date: 12/11/2003
Citizenship: United States of America

Full Name of Sixth Joint Inventor: **Brian D. Aizenstein**

Inventor's Signature: _____
Residence: 230 Glenway Street, Madison, WI 53705
Post Office Address: 230 Glenway Street, Madison, WI 53705

Date: _____
Citizenship: United States of America

Full Name of Seventh Joint Inventor: **Keith Davey**

Inventor's Signature: 
Residence: ~~10 Nantucket Court, Madison, WI 53719~~
Post Office Address: ~~10 Nantucket Court, Madison, WI 53719~~

Date: 12/15/2003
Citizenship: United States of America

8543 Ellington Way XMD
Middleton, WI 53562



PATENT
Attorney Docket No.: **FORS-08195**
Page 1 of 2

DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **Characterization of CYP 2D6 Genotypes**, the specification of which was filed on 07/10/03 as Application Serial No. **10/617,070**. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

10/411,954
60/371,819

04/11/03
04/11/02

Pending
Abandoned

Application Serial No.

Filing Date

Patented, Pending or Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under § 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole or First Inventor: **Matt Neville**

Inventor's Signature: _____ Date: 11/12/03
Residence: 54 Kingston Road, Oxford OX2 6RH, England ENGLAND Citizenship: Great Britain
Post Office Address: 54 Kingston Road, Oxford OX2 6RH, England

Full Name of Second Joint Inventor: **Monika de Arruda Indig**

Inventor's Signature: _____ Date: _____
Residence: 6618 Montclair Lane, Madison, WI 53711 Citizenship: United States of America
Post Office Address: 6618 Montclair Lane, Madison, WI 53711

Full Name of Third Joint Inventor: **Feng Cao**

Inventor's Signature: _____ Date: _____
Residence: 2428 N. 111th Street, #6, Milwaukee, WI 53226 Citizenship: People's Republic of China
Post Office Address: 2428 N. 111th Street, #6, Milwaukee, WI 53226

Full Name of Fourth Joint Inventor: **Mary C. Oldenburg**

Inventor's Signature: _____ Date: _____
Residence: 30 North Third Street, Madison, WI 53704 Citizenship: People's Republic of China
Post Office Address: 30 North Third Street, Madison, WI 53704

DECLARATION FOR PATENT APPLICATION (cont.)

PATENT
Attorney Docket No.: FORS-08195
Page 2 of 2

Full Name of Fifth Joint Inventor: James A. Koelbl

Inventor's Signature: _____

Residence: 1033 Tilda Trail, Cross Plains, WI 53528

Post Office Address: 1033 Tilda Trail, Cross Plains, WI 53528

Date: _____

Citizenship: United States of America

Full Name of Sixth Joint Inventor: Brian D. Alzenstein

Inventor's Signature: Brian Alzenstein

Residence: 230 Glenway Street, Madison, WI 53705

Post Office Address: 230 Glenway Street, Madison, WI 53705

Date: 12/16/03

Citizenship: United States of America

Full Name of Seventh Joint Inventor: Keith Davey

Inventor's Signature: _____

Residence: 10 Nantucket Court, Madison, WI 53719

Post Office Address: 10 Nantucket Court, Madison, WI 53719

Date: _____

Citizenship: United States of America